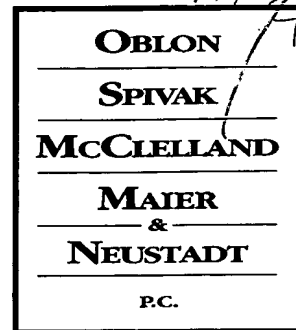




Docket No.: 213480US0

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313



ATTORNEYS AT LAW

RE: Application Serial No.: 09/942,626
Applicants: Sei TSUNODA, et al.
Filing Date: August 31, 2001
For: LOW DIELECTRIC CONSTANT MATERIAL
HAVING THERMAL RESISTANCE, INSULATION
FILM BETWEEN SEMICONDUCTOR LAYERS
USING THE SAME, AND SEMICONDUCTOR
DEVICE
Group Art Unit: 1751
Examiner: HAMLIN, D.G.

SIR:

Attached hereto for filing are the following papers:

Notice of Appeal; Request for Extension of Time (2 months)

Our credit card payment form in the amount of \$950.00 is attached covering any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R. 1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. 15-0030. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. 1.136 for the necessary extension of time. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.
Norman F. Oblon

Harris A. Pitlick

Registration No. 38,779

Customer Number

22850

(703) 413-3000 (phone)
(703) 413-2220 (fax)